antaira™

XFP-10G-S80 10G Ethernet XFP Transceiver

XFP, LC Connector, 1550nm Uncooled EML with APD Receiver, Single Mode, 80KM

Features

- 10Gb/s serial optical interface compliant to 802.3ae, 10GBASE ZR/ZW
- 1550nm cooled EML transmitter with TEC, APD photo-detector
- XFP Mechanical interface with bail latch and hot pluggable
- XFI High Speed Electrical Interface
- 2-wire interface for management and digital diagnostic monitor
- Operating case temperature: 0 to 70 °C
- All-metal housing for superior EMI performance
- Advanced firmware allow customer system encryption information to be stored in transceiver
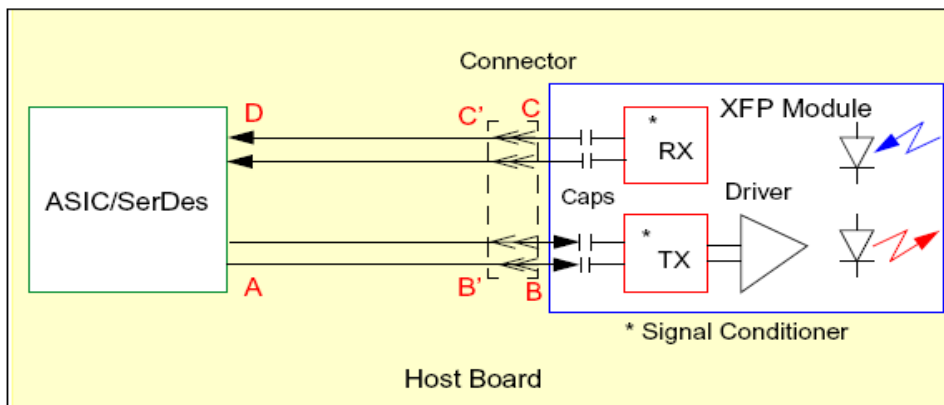- RoHS compliant
- No reference clock needed

Applications

- SONET(OC-192)/SDH(STM64) line card
- 10GBASE-ZR (10.3125Gbps)
- 10GBASE-ZW (9.953Gbps)
- 10GE Ethernet switches and routers
- 10GE Storage

Figure 1: Interface to Host

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General Description

The XFP-10G-S80 is a very compact 10Gb/s optical transceiver module for serial optical communication applications at 10Gb/s. The XFP-10G-S80 converts a 10Gb/s serial electrical data stream to 10Gb/s optical output signal and a 10Gb/s optical input signal to 10Gb/s serial electrical data streams. The high speed 10Gb/s electrical interface is fully compliant with XFI specification and allows FR4 host PCB trace up to 200mm.

The XFP-10G-S80 is designed for use in a variety of 10Gb/s SONET/SDH equipment including FEC (9.95Gb/s to 10.7Gb/s) and Ethernet LAN (10.3Gb/s) and WAN (9.95Gb/s) applications. The high performance cooled 1550nm EML transmitter and high sensitivity APD receiver provide superior performance for SONET/SDH and Ethernet applications at up to 80km links. The fully XFP compliant form factor provides hot pluggability easy optical port upgrades and low EMI emission.

Functional Description

The XFP-10G-S80 contains a duplex LC connector for the optical interface and a 30-pin connector for the electrical interface. Chart of section 3 shows the functional block diagram of XFP-10G-S80 XFP Transceiver.

Transmitter Operation

The transceiver module receives 10Gb/s electrical data and transmits the data as an optical signal. The transmitter contains a Clock Data Recovery (CDR) circuit that reduces the jitter of received signal and reshapes the electrical signal before the electrical to optical (E-O) conversion. The optical output power is maintained constant by an automatic power control (APC) circuit. The transmitter output can be turned off by TX disable signal, at TX_DIS pin. When TX_DIS is asserted high, the transmitter is turned off.

Receiver Operation

The received optical signal is converted to serial electrical data signal. The optical receiver contains a CDR circuits that reshapes and retimes an electrical signal before sending out to the XFI channel (i.e. XFP connector and high speed signal traces). The RX_LOS signal indicates insufficient optical power for reliable signal reception at the receiver.
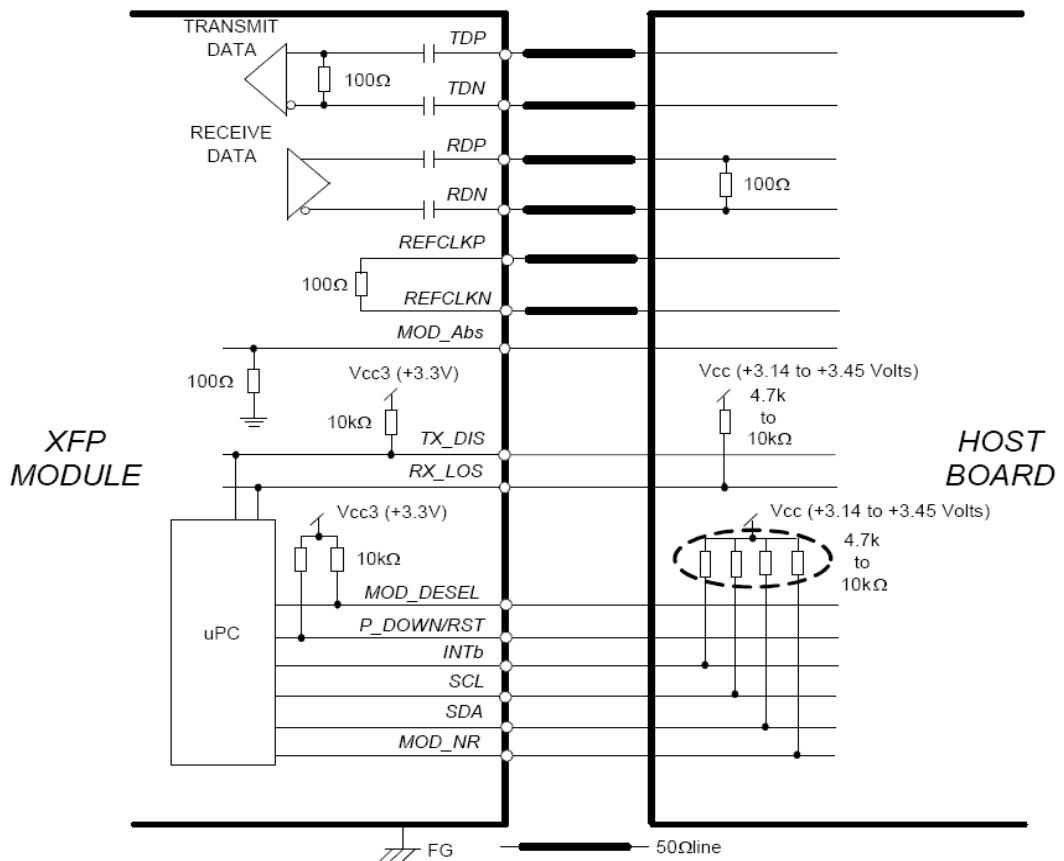
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Management Interface

A 2-wire interface (SCL, SDA) is used for serial ID, digital diagnostics and other control /monitor functions. The address of XFP transceiver is 1010000x. MOD_DESEL signal can be used in order to support multiple XFP modules on the same 2-wire interface bus. Interface is compliant to XFP MSA.

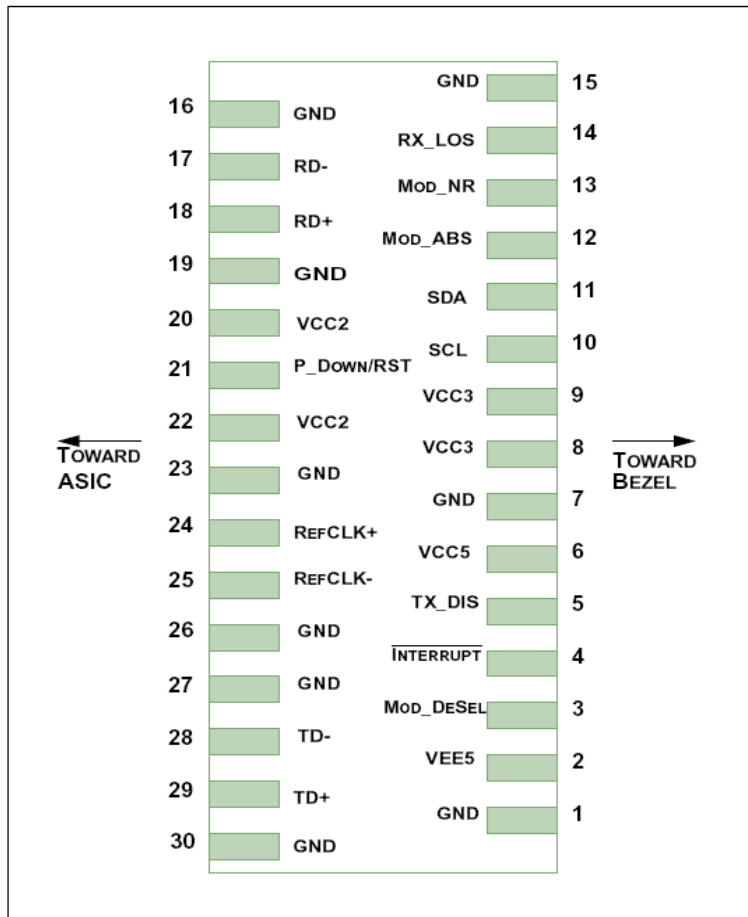## Recommended Electrical Interface to Host

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PIN DEFINITION

The XFP modules are hot-pluggable.   Hot pluggable refers to plugging in or unplugging a module while the host board is powered.   The XFP host connector is based on a 0.8 mm pitch 30 position right angle connector.   Host PCB pin assignment is given by Figure 2 and pin definition are listed in Table 2.   All XFP compliance points are defined using this connector. An improved version of this connector will be available from Tyco and possibly from other sources. It is recommended that host systems use the new improved connector for better signal integrity and EMI.

Interface to Host PCB

Pin Descriptions

Pin#	Name	Logic	Description	Note
1	GND		Module Ground	1
2	VEE5		-5.2V Power Supply , **not in use**	
3	MOD_DESEL	LVTTL-I	Module De-select; When held Low allows module to respond to 2-wire serial interface	
4	INTERRUPTb	LVTTL-O	Indicates presence of an important condition, which can be read over the 2-wire serial interface. This pin is an open collector output and must be pulled up to host_Vcc on the host board.	2
5	TX_DIS	LVTTL-I	Transmitter Disable; When asserted High, transmitter output is turned off. This pin is pulled up to VCC3 in the module	
6	VCC5		+5V Power Supply	
7	GND		Module Ground	1
8	VCC3		+3.3V Power Supply	
9	VCC3		+3.3V Power Supply	
10	SCL	I/O	2-wire serial interface clock. Host shall resistor connected to host_Vcc of +3.3V.	2
11	SDA	I/O	2-wire serial interface data. Host shall use a pull-up resistor connected to host_Vcc of +3.3V.	2
12	MOD_ABS	LVTTL-O	Indicates Module is not present. Host shall pull up this pin, and grounded in the module. "High" when the XFP module is absent from a host board.	2
13	MOD_NR	LVTTL-O	Module not ready; When High, Indicates Module Operational Fault. This pin is an open collector and must be pulled to host_Vcc on the host board.	2,3,4
14	RX_LOS	LVTTL-O	Receiver Loss of Signal; When high, indicates insufficient optical input power to the module. This pin is an open collector and must be pulled to host_Vcc on the host board.	2
15	GND		Module Ground	
16	GND		Module Ground	
17	RDN	CML-O	Receiver Inverted Data Output; AC coupled inside the module.	
18	RDP	CML-O	Receiver Non-Inverted Data Output; AC coupled in side the module.	
19	GND		Module Ground	1
20	VCC2		+1.8V Power Supply, **not in use**	

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Pin#	Name	Logic	Description	Note
21	P_DOWN/RST	LVTTL-I	Power down; When High, module is limited power mode. Low for normal operation. Reset; The falling edge indicates complete reset of the module. This pin is pulled up to VCC3 in the module.	
22	VCC2		+1.8V Power Supply, **not in use**	
23	GND		Module Ground	1
24	REFCLKP	PECL-I	Reference clock Non-Inverted Input; **not in use**	
25	REFCLKN	PECL-I	Reference clock Inverted Input; **not in use**	
26	GND		Module Ground	1
27	GND		Module Ground	1
28	TDN	CML-I	Transmitter Inverted Data Input; AC coupled inside the module.	
29	TDP	CML-I	Transmitter Non-Inverted Data Input; AC coupled inside the module.	
30	GND		Module Ground	1

*Notes: 1. Module ground pins are isolated from the module case and chassis ground within the module.

2. Shall be pulled up with 4.7k to 10k ohm to a voltage between 3.15V and 3.45V on the host board.

3. Response time: typ. 20msec (XFP MSA Rev. 4.5 ≦1msec)

4. MOD_NR = (TX LOL) OR (RX LOL).

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Note
Storage Temperature	Tst	-40	85	degC	
Relative Humidity (non-condensation)	RH	-	85	%	
Operating Case Temperature	Topc	0	70	degC	1
Supply Voltage #3	VCC3	-0.5	3.6	V	
Supply Voltage #5	VCC3	-0.5	6.0	V	
Voltage on LVTTL Input	Vilvttl	-0.5	VCC3+0.5	V	
LVTTL Output Current	Iolvttl	-	15	mA	
Voltage on Open Collector Output	Voco	0	6	V	
Receiver Input Optical Power(Average)	Mip	-	-7	dBm	2

*Notes: 1. Ta: -10 to 60degC with 1.5m/s airflow with an additional heat sink.

2. APD Receiver.

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Recommended Operating Conditions and Supply Requirements

Parameters	Symbol	Min	Max	Unit
Operating Case Temperature	Topc	0	70	degC
Relative Humidity (non-condensing)	Rhop	-	85	%
Main Power Supply Voltage #3	VCC3	3.13	3.45	V
Main Power Supply Current #3	ICC3	-	750	mA
Power Supply Voltage #5	VCC5	4.75	5.25	V
Power Supply Current #5	ICC5	-	300	mA
Total Power Consumption	Pd	-	3.5	W

Low Speed Control and Alarm Signals Electrical Interface

Parameters	Symbol	Min	Max	Units	Note
XFP Interrupt, Mod_NR, RX_LOS	Vol	0.0	0.4	V	1
	Voh	Vcc-0.5	Vcc+0.3		2
XFP TX_DIS, P_DOWN/RST	Vil	-0.3	0.8	V	3
	Vih	2.0	VCC3+0.3		4
XFP SCL and SDA Output	Vol	0.0	0.4	V	1
	Voh	Vcc-0.5	Vcc+0.3		2
XFP SCL and SDA Input	Vil	-0.3	VCC3*0.3	V	5
	Vih	VCC3*0.7	VCC3+0.5		6
Capacitance for XFP SCL and SDA I/O pin	Ci	-	14	pF	
Total bus capacitive load for SCL and SDA	Cb	-	100	pF	7
			400	pF	8

*Notes: 1. Pull-up resistor must be connected to host_Vcc on the host board. Iol(max)=3mA

2. Pull-up resistor must be connected to host_Vcc on the host board.

3. Pull-up resistor connected to VCC3 within XFP module. Iil(max)= -10µA.

4. Pull-up resistor connected to VCC3 within XFP module. Iih(max)= 10µA.

5. Pull-up resistor must be connected to host_Vcc on the host board. Iol(max)= -10µA.

6. Pull-up resistor must be connected to host_Vcc on the host board. Iol(max)= 10µA.

7. At 400KHz, 3.0kohms, at 100kHz 8.0kohms max.

8. At 400KHz, 0.8kohms, at 100kHz 2.0kohms max.

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Optical Interface

Transmitter Optical Interface						
Parameter	Symbol	Min	Typical	Max	Unit	Note
Operating Data Rate	-	9.95		10.70	Gb/s	1
Output Center Wavelength	ltc	1530	1550	1565	nm	
SMSR	SMSR	30		-	dB	
Average Output Power	Po	0		+4	dBm	2
Disabled Power	Poff	-		-30	dBm	2
Extinction Ratio	ER	9	10	-	dB	2
Eye Mask 1 (SONET/SDH)		GR-253-CORE/ITU-T G.691				2
Eye Mask 2 (10G Ethernet)		IEEE802.3ae				3
Generation Jitter 1 (20kHz - 80MHz)		-		0.15	UIp-p	2,4
Generation Jitter 2 (4MHz - 80MHz)		-		0.1	UIp-p	2,4
RIN	RIN	-		-130	dB/Hz	
Receiver Optical Interface						
Parameter	Symbol	Min	Typical	Max	Unit	Note
Operating Data Rate	-	9.95		10.70	Gb/s	1
Input Center Wavelength	lrc	1260		1600	nm	
Overload	Rovl	-7		-	dBm	
Minimum Sensitivity	Pmin	-	-	-24	dBm	2
RX_LOS Assert Level	RLOSa	-35			dBm	
RX_LOS Deassert Level	RLOSd			-30	dBm	
RX_LOS Hysteresis	RLOSh	1		5	dB	
Optical Path Penalty	PN	-		2	dB	1
Optical Return Loss	ORL	27		-	dB	
Jitter Tolerance	JTL	GR-253-CORE/ITU-T G.783				

*Notes: 1. Data rate tolerance

- SONET ,10GBASE-ZW:typ.+/-20ppm
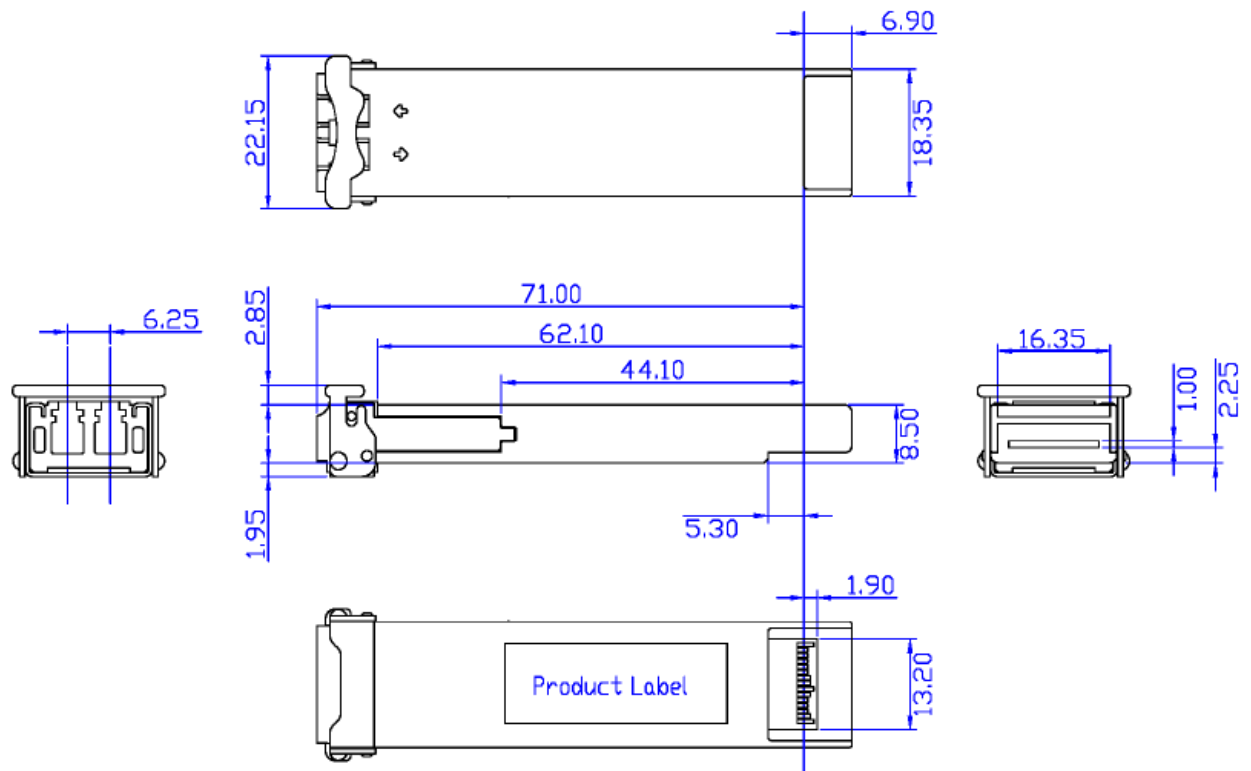
- 10GBASE-ZR: typ.+/-100ppm

2. Measured at 10.3125Gbps,Non-framed PRBS2^31-1,NRZ

3. Measured by using XFP evaluation board.

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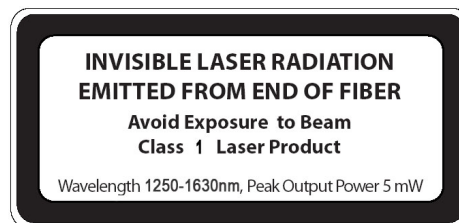## XFP-10G-S80 10G Ethernet XFP Transceiver

Mechanical Dimensions

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ESD

This transceiver is specified as ESD threshold 2kV for all electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM).   However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

Safety Information

- All versions of this laser are Class 1 laser products per IEC* 60825-1:2001. Users should observe safety precautions such as those recommended by ANSI** Z136.1-2000, ANSI Z36.2-1997 and IEC 60825-1:2001.
- Caution: use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

INVISIBLE LASER RADIATION EMITTED FROM END OF FIBER
Avoid Exposure to Beam
Class 1 Laser Product

Wavelength 1250-1630nm, Peak Output Power 5 mW

classified in accordance with IEC 60825-1: 2001-08

*IEC is a registered trademark of the International Electrotechnical Commission

**ANSI is a registered trademark of the American National Standards Institute

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